



#### P-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
201	$80m\Omega @ V_{GS} = -4.5V$	-3.7A
-20V	110mΩ @ V <sub>GS</sub> = -2.5V	-3.1A

## **Features and Benefits**

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Description**

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

## **Applications**

- General Purpose Interfacing Switch
- Power Management Functions

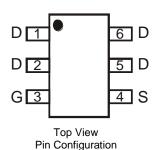
### **Mechanical Data**

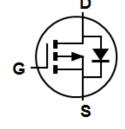
- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish—Tin Finish Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.013 grams (Approximate)





Top View





**Equivalent Circuit** 

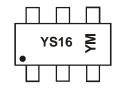
## Ordering Information (Note 4)

I	Part Number	Case	Packaging
Γ	DMP2109UVT-7	TSOT26	3000/Tape & Reel
I	DMP2109UVT-13	TSOT26	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- $4. For packaging details, go to our website at \ https://www.diodes.com/design/support/packaging/diodes-packaging/.$

# **Marking Information**



YS16 = Product Type Marking Code YM = Date Code Marking Y or Y = Year (ex: F = 2018) M = Month (ex: 9 = September)

Date Code Key

Year	2018	2019	20	020	2021	2022	2	2023	2024	20:	25	2026
Code	F	G		Н	1	J		K	L	N	1	N
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

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# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage			$V_{DSS}$	-20	V
Gate-Source Voltage			$V_{GSS}$	±10	V
Continuous Drain Current (Note 6) V <sub>GS</sub> = -4.5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	-3.7 -2.9	А
Continuous Drain Current (Note 6) V <sub>GS</sub> = -2.5V	I <sub>D</sub>	-3.1 -2.5	А		
Maximum Continuous Body Diode Forward Curre	ent (Note 6)	Is	-1.2	Α	
Pulsed Drain Current (10µs Pulse, Duty Cycle =	1%)	I <sub>DM</sub>	-20	A	

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		$P_{D}$	1.2	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R <sub>OJA</sub>	105	°C/W
Total Power Dissipation (Note 6)		P <sub>D</sub>	1.0	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R <sub>OJA</sub>	77	°C/W
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>	_	_	-1.0	μΑ	$V_{DS} = -16V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 8V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.45	l	-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance	D		54	80	mΩ	$V_{GS} = -4.5V, I_D = -2.8A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	70	110	11177	$V_{GS} = -2.5V, I_D = -2.0A$	
Diode Forward Voltage	$V_{SD}$	_	-0.7	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	443	_	pF	., , , , , , , , , , , , , , , , , , ,	
Output Capacitance	Coss	_	59	_	pF	$V_{DS} = -10V, V_{GS} = 0V$ - f = 1.0MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	47	_	pF	1 = 1.000112	
Gate Resistance	Rg	_	8.5	_	Ω	$V_{GS} = 0V, V_{DS} = 0V, f = 1.0MHz$	
Total Gate Charge	$Q_g$	_	6.0	_	nC		
Gate-Source Charge	$Q_{gs}$	_	0.6	_	nC	$V_{GS} = -4.5V$ , $V_{DS} = -10V$ , $I_{D} = -3A$	
Gate-Drain Charge	$Q_{gd}$	_	1.8	_	nC	]	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	4.0	_	ns		
Turn-On Rise Time	t <sub>R</sub>	_	3.7	_	ns	$V_{DS} = -10V, V_{GS} = -4.5V,$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	24.5	_	ns	$R_L = 10\Omega, R_G = 1.0\Omega, I_D = -1A$	
Turn-Off Fall Time	t <sub>F</sub>	_	9.5	1	ns		
Reverse Recovery Time	t <sub>RR</sub>	_	8.3	_	ns	$I_F = -1.0A$ , $di/dt = 100A/\mu s$	
Reverse Recovery Charge	$Q_{RR}$	_	2.0	_	nC	$I_F = -1.0A$ , $di/dt = 100A/\mu s$	

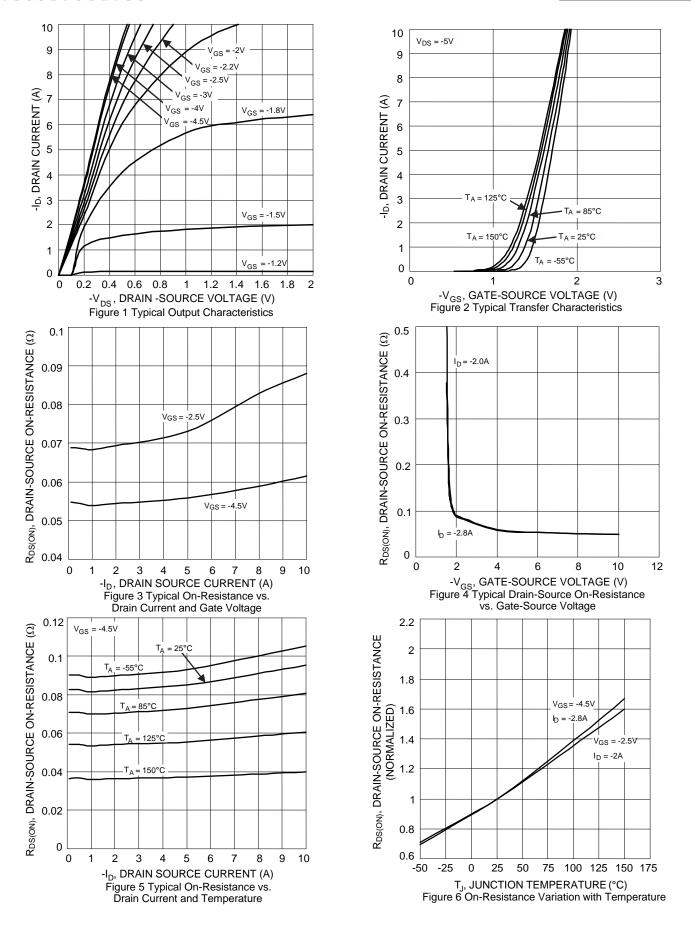
Notes:

- Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout.
   Device mounted on FR-4 substrate PCB, 2oz copper, with 1inch square copper plate.
   Short duration pulse test used to minimize self-heating effect.

- 8. Guaranteed by design. Not subject to product testing.

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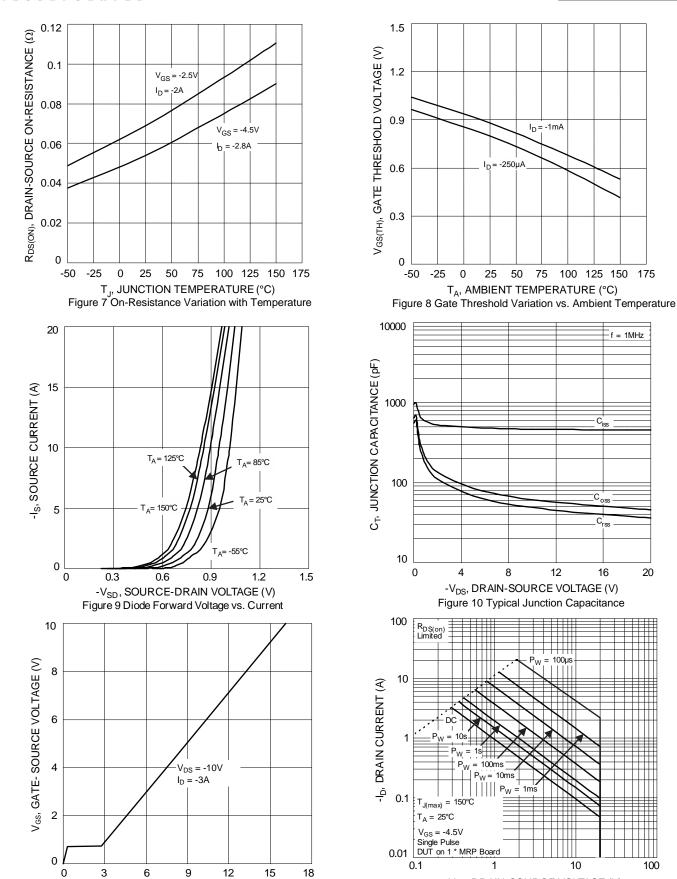


f = 1MHz

16

20





 $Q_{q}$ , TOTAL GATE CHARGE (nC)

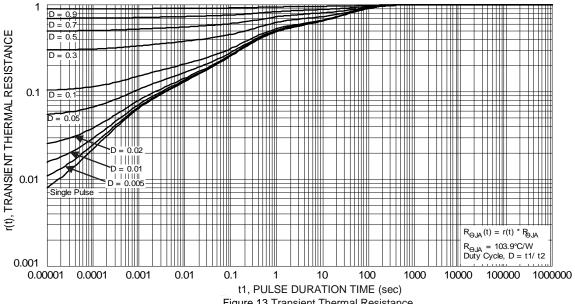
Figure 11 Gate Charge

100

-V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V)

Figure 12 SOA, Safe Operation Area

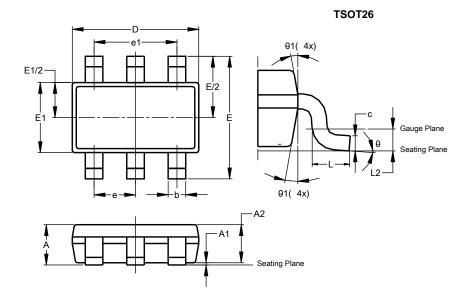






# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

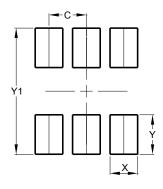


TSOT26							
Dim	Min	Max	Тур				
Α	_	1.00	_				
A1	0.010	0.100	_				
A2	0.840	0.900	_				
D	2.800	3.000	2.900				
Е	2	.800 BS	C				
E1	1.500	1.700	1.600				
b	0.300	0.450	_				
С	0.120	0.200	_				
е	0.950 BSC						
e1	1	.900 BS	C				
L	0.30	0.50	_				
L2	0.250 BSC						
θ	0°	8°	4°				
θ1	4°	12°	_				
All Dimensions in mm							

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TSOT26



Dimensions	Value (in mm)				
С	0.950				
Х	0.700				
Y	1.000				
V1	2 100				



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